

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): SHIMOKAWA, et al.
Filed: October 9, 2001
For: PB-FREE SOLDER-CONNECTED STRUCTURE AND
ELECTRONIC DEVICE

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

October 9, 2001

Sir:

Please amend the above-identified application, prior to examination
thereof, as follows:

IN THE SPECIFICATION

Page 1, between the title and the heading "TECHNICAL FIELD", please
add the following new paragraph:

--This application is a Continuation application of prior application Serial
No. 09/581,631, filed June 15, 2000, which is a national stage application under
35 USC 371 of International (PCT) Application No. PCT/JP98/05565, filed
December 9, 1998.--

REMARKS

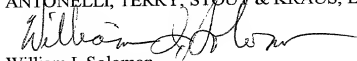
Applicants have amended the specification of the above-identified application, on the first page of the specification thereof, consistent with the requirements of 35 USC 120, to refer to prior application Serial No. 09/581,631. Clearly, this amendment of the specification does not add new matter to the application.

Entry of the present amendment to the specification, and examination of the above-identified application in due course, are respectfully requested.

To the extent necessary, Applicants petition for an extension of time under 37 CFR § 1.136. Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to the Deposit Account No. 01-2135 (Case No. 500.38665CX1) and please credit any excess fees to such Deposit Account.

Respectfully submitted,

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